

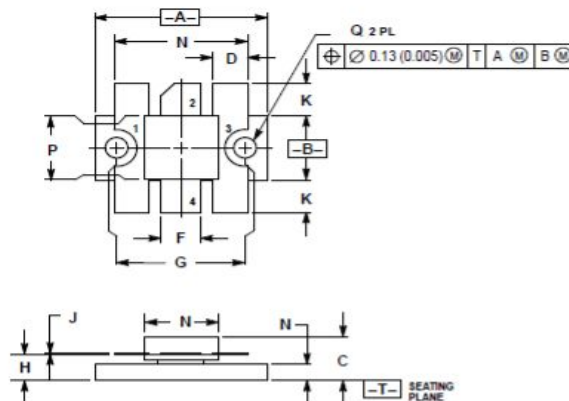
SILICON MOS N-CHANNEL RF POWER TRANSISTOR 100 W, up to 400 MHz, Enhancement Mode

MRF175LU

Designed primarily for wideband large-signal output and driver from 30–400 MHz.

Features:

- Performance at 400 MHz, 28 Vdc
- Power Gain: 8 dB Min
- Output Power: 100 W
- Efficiency: 55 % Min



Absolute Maximum Ratings

| Parameters | Sym | Value | Unit |
|---|-----------------|-------------|---------------|
| Drain-Source Voltage | V_{DSS} | 65 | V_{DC} |
| Drain Current-Continuous | I_D | 8.0 | A_{DC} |
| Gate-Source Voltage | V_{GS} | ± 40 | V_{DC} |
| Storage Temperature Range | T_{STG} | -65 tu +150 | $^{\circ}C$ |
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 0.65 | $^{\circ}C/W$ |
| Total Power Dissipation @ $T_C=25^{\circ}C$ | P_D | 270 | W |

CASE 333-04

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.965 | 0.965 | 24.51 | 25.02 |
| B | 0.390 | 0.410 | 9.91 | 10.41 |
| C | 0.290 | 0.290 | 6.73 | 7.36 |
| D | 0.190 | 0.210 | 4.83 | 5.33 |
| E | 0.095 | 0.115 | 2.42 | 2.92 |
| F | 0.215 | 0.235 | 5.47 | 5.96 |
| G | 0.725 BSC | | 18.42 BSC | |
| H | 0.155 | 0.175 | 3.94 | 4.44 |
| J | 0.004 | 0.006 | 0.10 | 0.15 |
| K | 0.195 | 0.205 | 4.95 | 5.21 |
| L | 0.740 | 0.770 | 18.80 | 19.55 |
| N | 0.415 | 0.425 | 10.54 | 10.80 |
| P | 0.390 | 0.400 | 9.91 | 10.16 |
| Q | 0.120 | 0.135 | 3.05 | 3.42 |

Parameters

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|--|---------------|------|------|------|--------------|
| Drain-Source Breakdown Voltage ($I_D=5.0\text{ mA}$, $V_{GS}=0\text{ V}$) | $V_{(BR)DSS}$ | 65 | — | — | V_{DC} |
| Gate-Source Leakage Current ($V_{GS}=20\text{ V}$, $V_{DS}=0\text{ V}$) (1) | I_{GSS} | — | — | 1.0 | μA_{DC} |
| Zero Gate Voltage Drain Leakage Current ($V_{DS} = 28\text{ V}$, $V_{GS}=0\text{ V}$) | I_{DSS} | — | — | 2.5 | mA_{DC} |
| Gate Threshold Voltage ($V_{DS} = 10\text{ V}$, $I_D = 100\text{ mA}$) | $V_{GS(TH)}$ | 1 | — | 6 | V_{DC} |
| Forward Transconductance ($V_{DS} = 10\text{ V}$, $I_D = 2.5\text{ A}$) | G_{FS} | 2 | 3 | — | mhos |
| Input Capacitance ($V_{DS} = 28\text{ V}$, $V_{GS}=0\text{ V}$, $f = 1\text{ MHz}$) | C_{ISS} | — | 180 | — | pF |
| Output Capacitance ($V_{DS} = 28\text{ V}$, $V_{GS}=0\text{ V}$, $f = 1\text{ MHz}$) | C_{OSS} | — | 200 | — | pF |
| Reverse Transfer Capacitance ($V_{DS} = 28\text{ V}$, $V_{GS}=0\text{ V}$, $f = 1\text{ MHz}$) | C_{RSS} | — | 20 | — | pF |
| Power Gain ($V_{DS} = 28\text{ V}$, $P_{OUT} = 100W$, $I_{DQ} = 100\text{ mA}$, $f = 400\text{ MHz}$) | G_p | 8 | 10 | — | dB |
| Drain Efficiency ($V_{DS} = 28\text{ V}$, $P_{OUT} = 100\text{ W}$, $I_{DQ} = 100\text{ mA}$, $f = 400\text{ MHz}$) | η_D | 55 | 60 | — | % |

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